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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/623,965	07/21/2003	Qing Ma	42390.P8877D	5335
75	590 11/30/2004		EXAM	INER
Todd M. Becker			GEBREMARIAM, SAMUEL A	
BLAKELY, SC	KOLOFF, TAYLOR & Z	ZAFMAN LLP		
Seventh Floor	•		ART UNIT	PAPER NUMBER
12400 Wilshire	Boulevard		2811	
Los Angeles, C	CA 90025-1026		DATE MAILED, 11/20/200	4

Please find below and/or attached an Office communication concerning this application or proceeding.

<u> </u>			M		
	Application No.	Applicant(s)	70		
Office Action Summary	10/623,965	MA ET AL.			
Office Action Summary	Examiner	Art Unit			
TI - MAN INO DATE - CAL:	Samuel A Gebremariam	2811			
- The MAILING DATE of this communication appeared for Reply	ears on the cover sheet with the c	orresponaence add	ress		
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply if NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	6(a). In no event, however, may a reply be time within the statutory minimum of thirty (30) days ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	nely filed s will be considered timely, the mailing date of this con D (35 U.S.C. § 133).	nmunication.		
Status					
1) Responsive to communication(s) filed on 07 Se	eptember 2004.				
2a) ☐ This action is FINAL . 2b) ☐ This	action is non-final.				
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.				
Disposition of Claims					
4) ☐ Claim(s) 14-25 is/are pending in the application 4a) Of the above claim(s) is/are withdraw 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 14-25 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	n from consideration.				
Application Papers					
9) The specification is objected to by the Examine	r.				
10) The drawing(s) filed on is/are: a) acce	epted or b) objected to by the I	Examiner.			
Applicant may not request that any objection to the o	drawing(s) be held in abeyance. See	e 37 CFR 1.85(a).			
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priori application from the International Bureau * See the attached detailed Office action for a list of	s have been received. s have been received in Applicati ity documents have been receive (PCT Rule 17.2(a)).	on No ed in this National S	stage		
Attachment(s)					
1) Notice of References Cited (PTO-892)	4) Interview Summary	(PTO-413)			
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ite	152)		
S. Patent and Trademark Office					

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 14-15, 19, 23 and 24 are rejected under 35 U.S.C. 102(b) as being anticipated by Barron et al., US patent No. 5,919,548.

Regarding claim 14, Barron teaches (figs. 3a-3r and 4a-4c) a process of forming a micro electromechanical (MEMS) package (col. 11, lines 46-53) comprising: providing a semiconductor device (10, 300) including an active surface (top surface 10); providing a conveyance (24) with at least one embedded MEMS device (20) disposed therein; and disposing the conveyance over the semiconductor device, wherein the at least one embedded MEMS device communicates electrically to the semiconductor device (region 20 communicates with regions 302 and 304).

Regarding claim 15, Barron teaches the entire claimed structure of claim 14 above including the at least one embedded MEMS device is a capacitor (col. 6, lines 24-27).

Regarding claim 16, Barron teaches the entire claimed structure of claim 14 above including the conveyance comprises a via (32) disposed therein the process further comprising: providing at least one detached MEMS (38) device in a first

structure; and accommodating the at least one detached MEMS device through the via, upon the active surface of the device (top surface of 10).

Regarding claim 17, Barron teaches the entire claimed structure of claim 14 above including the conveyance comprises a via (32) disposed therein the process further comprising: providing at least one detached MEMS (38) device in a first structure; placing the at least one detached MEMS device on the semiconductor device (10, 300); and accommodating the at least one detached MEMS device through the via upon the active surface of the device (see fig. 3j-3l).

Regarding claims 19 and 20, Barron teaches the entire claimed structure of claim 14, 16 and 17 above including forming an integrated package comprising the semiconductor device and the conveyance (col. 11, lines 46-53).

Regarding claims 21 and 22, Barron teaches the entire claimed structure of claim 14, 16 and 17 above including encapsulating the detached MEMS device and the conveyance to form an integrated package (col. 10, lines 18-45 and fig. 3m).

Regarding claim 23, Barron teaches a process comprising: providing a semiconductor device (10, 300); accommodating a detached micro electromechanical (20) structure (MEMS) device upon the semiconductor device; providing a conveyance (24) over the semiconductor device and around the detached MEMS device (20); and contacting encapsulation material with at least one of the semiconductor device, the detached MEMS device, and the conveyance to form an integrated MEMS package (col. 11, lines 46-53 and col. 10, lines 18-45 and fig. 3m).

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Regarding claim 24, Barron teaches the entire claimed structure of claim 23 above including embedding a MEMS (38) device in the conveyance (24).

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 18 and 25 are rejected under 35 U.S.C. 103(a) as being unpatentable over Barron.

Regarding claims 18, Barron teaches substantially the entire claimed structure of claims 14, 16 and 17 above except explicitly stating providing a sealing structure; and disposing the sealing structure in a manner sufficient to isolate at least one of the at least one detached MEMS device.

Barron teaches forming a sealed cavity MEMS device (200) without stating that individual MEMS are being sealed (col. 11, lines 46-53).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to provide a sealing structure as claimed in the process of Barron in order to provide good protection against moisture.

Regarding claims 25, Barron teaches substantially the entire claimed structure of claim 23 above except explicitly stating that providing a sealing structure; and interposing the sealing structure upon the semiconductor device in a manner sufficient to isolate at least one of the at least one detached MEMS device.

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Barron teaches forming a sealed cavity MEMS device (200) without stating that individual MEMS are being sealed (col. 11, lines 46-53).

It would have been obvious to one of ordinary skill in the art at the time the invention was made to provide a sealing structure as claimed in the process of Barron in order to provide good protection against moisture.

Response to Arguments

5. Applicant's arguments filed on 9/07/2004 have been fully considered but they are not persuasive. Applicant argues that the Baron reference does not teach the limitation of a semiconductor device and an embedded MEMS device. Element (12) identified to be a semiconductor device in the instant application only shows a structure that appears to a substrate. Therefore element (10) of Baron's structure meets the claimed limitation of a semiconductor device as shown in the figures. Furthermore as clearly shown in column 7, lines 50-57, element (20) can be an electrostatic comb actuator or a sensor which is a MEMS device. Therefore element (20) of Baron's structure meets the limitation of MEMS device that is embedded in a conveyance (24). Conveyance is taken to mean "a means or a way of conveying". Furthermore applicant argues that the Baron reference does not teach the claimed limitation of a detached MEMS device. Since Baron teaches a plurality of individual MEMS structure (20) as shown in the figures, the reference meets the limitation of a detached MEMS device. In addition the claim does not preclude MEMS structures that are embedded and at the same time detached from each other.

Conclusion

6. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Samuel A Gebremariam whose telephone number is (571) 272-1653. The examiner can normally be reached on 8:00am-4:30pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie Lee can be reached on (571) 272-1732. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

SAG November 17, 2004

> EDDIE LEE SUPERVISORY PATENT EXAMINER

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